

# Optical communication Package

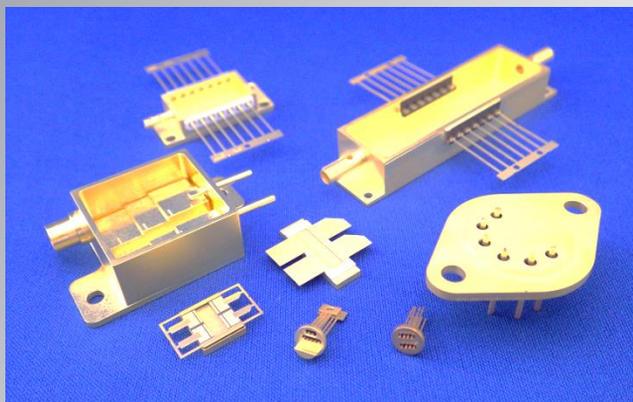
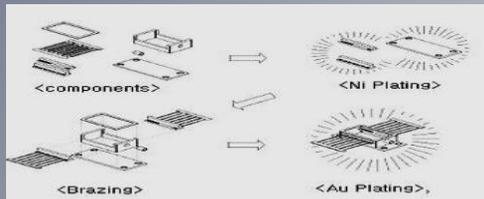


少量多品種の需要に対し、  
迅速に製造対応します。

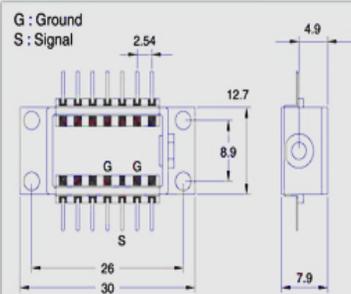
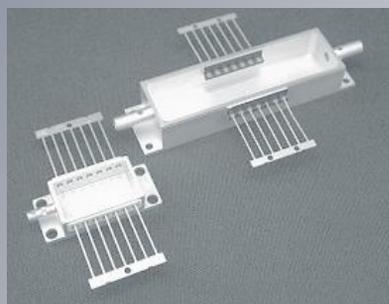
《用途》

●光通信デバイス用

《加工内容》



## BTF PACKAGE

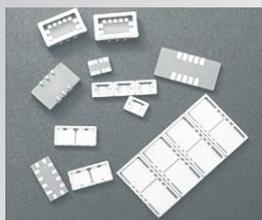


Component	Material
Base Plate	W-Cu
Wall	Kover / Alloy42
Multi-layer Ceramic	Alumina
Load Frame	Kover (Etching)
Pipe	Kover (Machining)
Lid	Kover (Etching / Press)

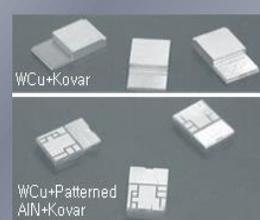
### TO3-STEM



### CERAMIC PKG

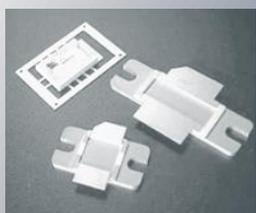
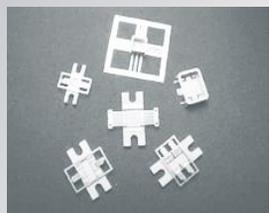


### SUB-COMPONENT

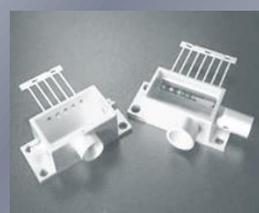


## RF-PKG

### RF PKG Power Application



### RF Connector PKG



※ご希望仕様により上記仕様は変わります。まずは、お問い合わせください。

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